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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of:

Group Art Unit: 1725

YUJI HORI et al.

Examiner: Unknown

Serial No.: 10/783,740

Filed: February 20, 2004

For: WATER-SOLUBLE CASTING MOLD AND METHOD FOR
MANUFACTURING THE SAME

Attorney Docket No.: AOY 0102 PUSA

TRANSMITTAL OF SUPPLEMENTAL DECLARATION

Commissioner for Patents
U.S. Patent & Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Enclosed with reference to the above-identified patent application is a Supplemental Declaration executed by inventor Kambayashi. A Declaration executed by all inventors was previously filed. The residence of inventor Kambayashi identified in the previously filed Declaration was incorrect. The residence (Shimane, Japan) of inventor Kambayashi identified in the enclosed Supplemental Declaration is correct.

Respectfully submitted,

YUJI HORI et al.

By:

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Date: February 7, 2005
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CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this paper, including all enclosures referred to herein, is being deposited with the United States Postal Service as first-class mail, postage pre-paid, in an envelope addressed to: Commissioner for Patents, U.S. Patent & Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450 on:

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Name of Person Signing

Signature

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DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

Atty. Docket No. AOYO102PUSA(I hereby authorize my attorney to insert the
Attorney Docket No. when it becomes known)First Named Inventor Yuji HORI et al.

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

WATER-SOLUBLE CASTING MOLD AND METHOD FOR MANUFACTURING THE SAME

the specification of which:

[] is attached hereto; or
[X] was filed on (MM/DD/YYYY) 02/20/2004 as U.S. Application Number or PCT International Application Number 10/783,740, and was amended on (MM/DD/YYYY) _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below, and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application Number(s)	Country	Foreign Priority Date (MM/DD/YYYY)	Priority Not Claimed	Certified Copy Attached? (Yes/No)
2003-043692	Japan	02/21/2003		

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

Application Number(s)	Filing Date (MM/DD/YYYY)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Application Number(s)	Filing Date (MM/DD/YYYY)	Status: Patented, Pending, Abandoned

Declaration for Patent Application (cont'd.)Atty. Docket No. : AOY0102PUSA

I hereby appoint the practitioners associated with Customer Number 22045 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Address all correspondence and telephone calls to BK Domestic Patent Filing Dept. at Brooks & Kushman P.C., 1000 Town Center, Twenty-Second Floor, Southfield, Michigan 48075, (248) 358-4400.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole or First Inventor Yuji HORI

Inventor's signature _____

Date _____

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Inventor's signature _____

Date _____

Mailing address c/o TSUCHIYOSHI INDUSTRY CO., LTD., 3-26, Kamitenma-cho, Nishi-ku, Hiroshima-shi, Hiroshima 733-0021 JapanResidence Hiroshima, JapanCitizenship Japan*Full Name of Fourth Joint Inventor* Hitoshi KAMBAYASHIInventor's signature Hitoshi KambayashiDate February 4, 2005Mailing address c/o TSUCHIYOSHI INDUSTRY CO., LTD., 1988-2, Asari-cho, Goutsu-shi, Shimane 695-0002 JapanResidence Shimane, JapanCitizenship Japan